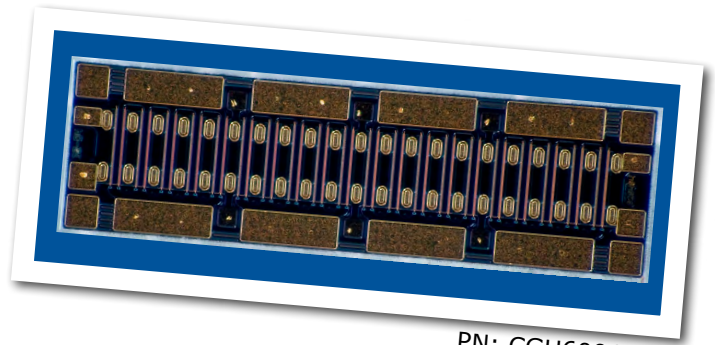


# CGH60060D

**60 W, 6.0 GHz, GaN HEMT Die**

Cree's CGH60060D is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity, and higher thermal conductivity. GaN HEMTs offer greater power density and wider bandwidths compared to Si and GaAs transistors.



PN: CGH60060D

## FEATURES

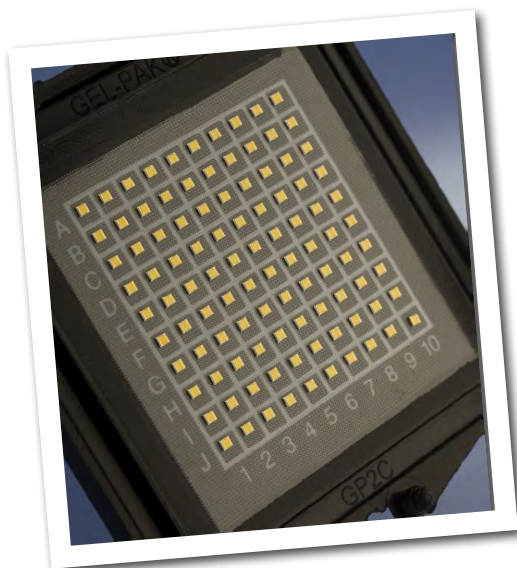
- 13 dB Typical Small Signal Gain at 4 GHz
- 12 dB Typical Small Signal Gain at 6 GHz
- 60 W Typical  $P_{SAT}$
- 28 V Operation
- High Breakdown Voltage
- High Temperature Operation
- Up to 6 GHz Operation
- High Efficiency

## APPLICATIONS

- 2-Way Private Radio
- Broadband Amplifiers
- Cellular Infrastructure
- Test Instrumentation
- Class A, AB, Linear amplifiers suitable for OFDM, W-CDMA, EDGE, CDMA waveforms



## Packaging Information



- Bare die are shipped in Gel-Pak® containers.
- Non-adhesive tacky membrane immobilizes die during shipment.

Large Signal Models Available for SiC & GaN



## Absolute Maximum Ratings (not simultaneous) at 25 °C

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	$V_{DS}$	84	VDC	25 °C
Gate-source Voltage	$V_{GS}$	-10, +2	VDC	25 °C
Storage Temperature	$T_{STG}$	-65, +150	°C	
Operating Junction Temperature	$T_J$	225	°C	
Maximum Forward Gate Current	$I_{GMAX}$	15	mA	25 °C
Maximum Drain Current <sup>1</sup>	$I_{DMAX}$	6	A	25 °C
Thermal Resistance, Junction to Case (packaged) <sup>2</sup>	$R_{\theta JC}$	2.8	°C/W	
Thermal Resistance, Junction to Case (die only)	$R_{\theta JC}$	1.5	°C/W	85 °C
Mounting Temperature (30 seconds)	$T_S$	320	°C	30 seconds

Note<sup>1</sup> Current limit for long term, reliable operation

Note<sup>2</sup> Eutectic die attach using 80/20 AuSn mounted to a 60 mil thick CuMoCu carrier.

## Electrical Characteristics (Frequency = 4 GHz unless otherwise stated; $T_C = 25 °C$ )

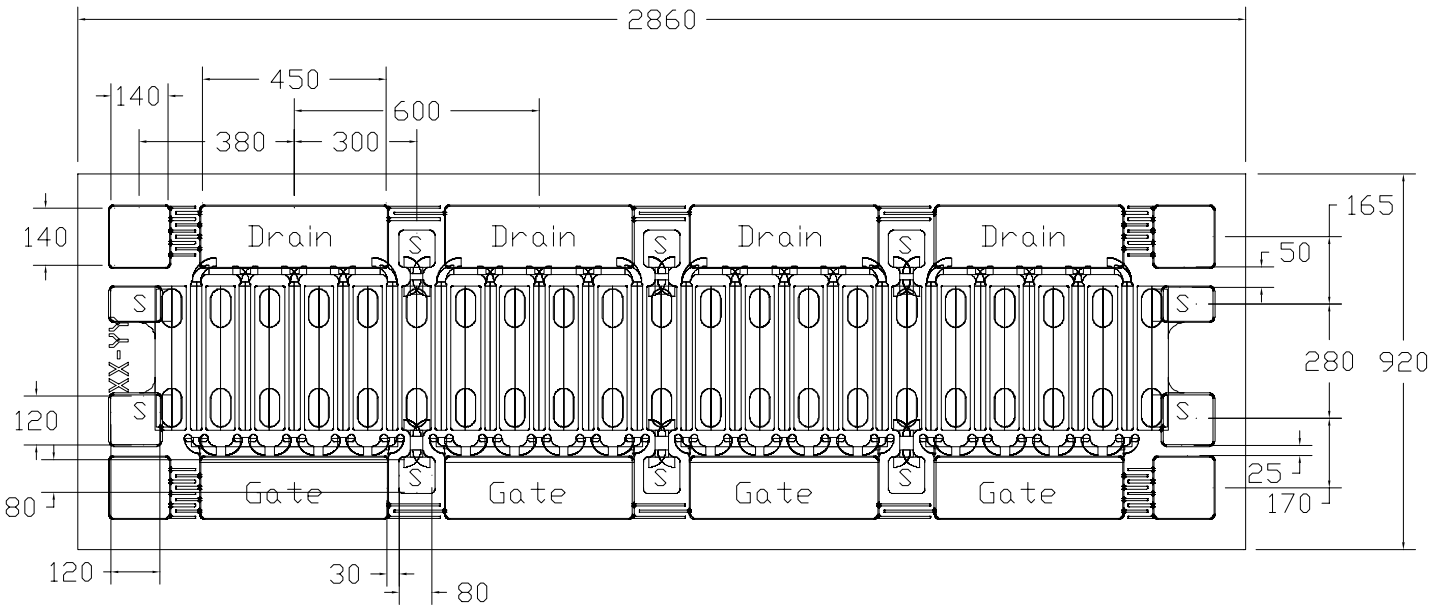
Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>DC Characteristics</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	-3.8	-3.0	-2.3	V	$V_{DS} = 10 V, I_D = 14.4 mA$
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V <sub>DC</sub>	$V_{DD} = 28 V, I_{DQ} = 400 mA$
Drain Current	$I_{DS}$	11.6	14.0	-	A	$V_{DS} = 6.0 V, V_{GS} = 2.0 V$
Drain-Source Breakdown Voltage	$V_{BD}$	120	-	-	V	$V_{GS} = -8 V, I_D = 14.4 mA$
On Resistance	$R_{ON}$	-	0.25	-	Ω	$V_{DS} = 0.1 V$
Gate Forward Voltage	$V_{G-ON}$	-	1.9	-	V	$I_{GS} = 14.4 mA$
<b>RF Characteristics</b>						
Small Signal Gain	$G_{SS}$	-	13	-	dB	$V_{DD} = 28 V, I_{DQ} = 400 mA$
Saturated Power Output <sup>1</sup>	$P_{SAT}$	-	60	-	W	$V_{DD} = 28 V, I_{DQ} = 400 mA$
Drain Efficiency <sup>2</sup>	$\eta$	-	65	-	%	$V_{DD} = 28 V, I_{DQ} = 400 mA, P_{SAT} = 60 W$
Intermodulation Distortion <sup>3</sup>	IM3	-	-30	-	dBc	$V_{DD} = 28 V, I_{DQ} = 400 mA, P_{OUT} = 60 W PEP$
Output Mismatch Stress	VSWR	-	-	10 : 1	Ψ	No damage at all phase angles, $V_{DD} = 28 V, I_{DQ} = 400 mA, P_{OUT} = 60 W CW$
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{GS}$	-	17.0	-	pF	$V_{DS} = 28 V, V_{gs} = -8 V, f = 1 MHz$
Output Capacitance	$C_{DS}$	-	3.5	-	pF	$V_{DS} = 28 V, V_{gs} = -8 V, f = 1 MHz$
Feedback Capacitance	$C_{GD}$	-	0.8	-	pF	$V_{DS} = 28 V, V_{gs} = -8 V, f = 1 MHz$

### Notes:

<sup>1</sup>  $P_{SAT}$  is defined as  $I_G = 1.4 mA$ .

<sup>2</sup> Drain Efficiency =  $P_{OUT} / P_{DC}$ .

## DIE Dimensions (units in microns)



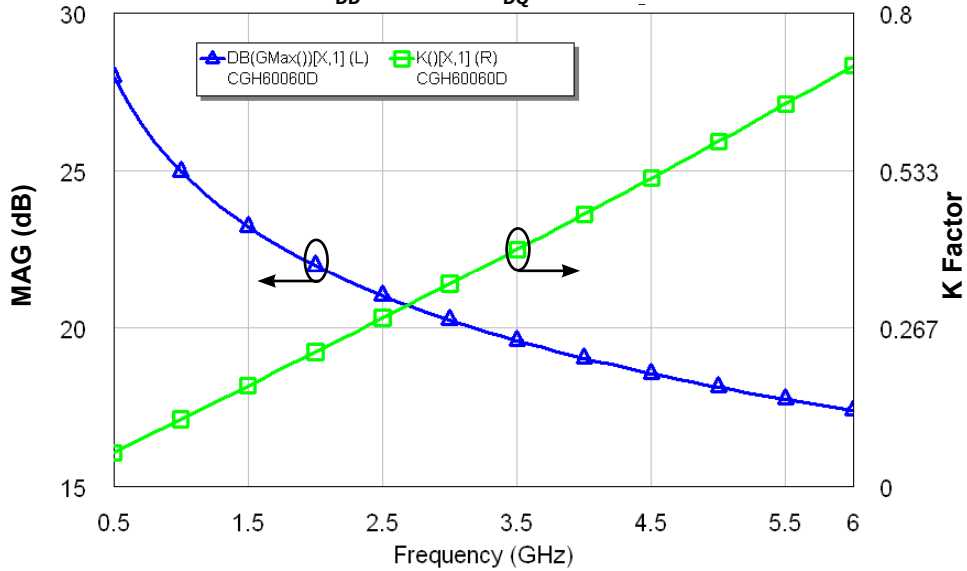
Overall die size 2860 x 920 (+0/-50) microns, die thickness 100 (+/- 10) microns.  
All Gate and Drain pads must be wire bonded for electrical connection.

### Assembly Notes:

- Recommended solder is AuSn (80/20) solder. Refer to Cree's website for the Eutectic Die Bond Procedure application note at [http://www.cree.com/products/wireless\\_documents.asp](http://www.cree.com/products/wireless_documents.asp)
- Vacuum collet is the preferred method of pick-up.
- The backside of the die is the Source (ground) contact.
- Die back side gold plating is 5 microns thick minimum.
- Thermosonic ball or wedge bonding are the preferred connection methods.
- Gold wire must be used for connections.
- Use the die label (XX-YY) for correct orientation.

## Typical Performance

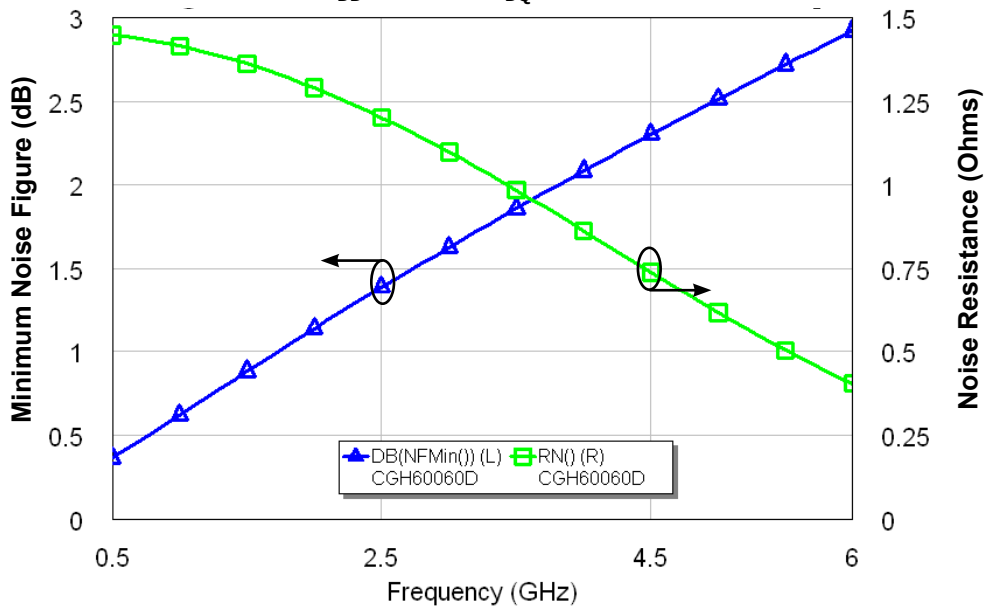
**Simulated Maximum Available Gain and K Factor of the CGH60060D**  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 400\text{ mA}$



Intrinsic die parameters - reference planes at centers of gate and drain bonding pads. No wire bonds assumed.

## Typical Noise Performance

**Simulated Minimum Noise Figure and Noise Resistance vs Frequency of the CGH60060D**  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 400\text{ mA}$





**Typical Die S-Parameters (Small Signal,  $V_{DS} = 28\text{ V}$ ,  $I_{DQ} = 400\text{ mA}$ , magnitude / angle)**

Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.958	-168.55	7.79	88.19	0.012	-1.00	0.654	-172.20
600 MHz	0.958	-170.42	6.48	85.81	0.012	-3.22	0.657	-172.35
700 MHz	0.958	-171.76	5.54	83.69	0.012	-5.16	0.661	-172.29
800 MHz	0.959	-172.76	4.83	81.75	0.012	-6.94	0.664	-172.13
900 MHz	0.959	-173.54	4.28	79.93	0.012	-8.59	0.668	-171.90
1.0 GHz	0.959	-174.16	3.83	78.20	0.012	-10.15	0.672	-171.63
1.1 GHz	0.960	-174.67	3.47	76.54	0.012	-11.65	0.676	-171.34
1.2 GHz	0.960	-175.09	3.16	74.94	0.012	-13.09	0.681	-171.05
1.3 GHz	0.960	-175.45	2.90	73.38	0.012	-14.48	0.686	-170.76
1.4 GHz	0.961	-175.76	2.68	71.86	0.012	-15.83	0.691	-170.47
1.5 GHz	0.961	-176.03	2.48	70.38	0.012	-17.15	0.696	-170.20
1.6 GHz	0.962	-176.27	2.31	68.93	0.012	-18.43	0.701	-169.95
1.7 GHz	0.962	-176.48	2.16	67.51	0.012	-19.68	0.706	-169.71
1.8 GHz	0.963	-176.67	2.02	66.13	0.012	-20.91	0.712	-169.49
1.9 GHz	0.963	-176.84	1.90	64.77	0.011	-22.10	0.718	-169.29
2.0 GHz	0.964	-177.00	1.79	63.43	0.011	-23.27	0.723	-169.11
2.1 GHz	0.964	-177.14	1.69	62.13	0.011	-24.41	0.729	-168.95
2.2 GHz	0.965	-177.27	1.60	60.85	0.011	-25.52	0.735	-168.81
2.3 GHz	0.965	-177.40	1.51	59.59	0.011	-26.62	0.740	-168.69
2.4 GHz	0.966	-177.51	1.44	58.36	0.011	-27.68	0.746	-168.59
2.5 GHz	0.966	-177.62	1.37	57.15	0.011	-28.73	0.752	-168.50
2.6 GHz	0.967	-177.72	1.30	55.96	0.011	-29.75	0.757	-168.43
2.7 GHz	0.967	-177.82	1.24	54.80	0.011	-30.74	0.763	-168.38
2.8 GHz	0.968	-177.92	1.18	53.66	0.010	-31.72	0.768	-168.34
2.9 GHz	0.969	-178.01	1.13	52.54	0.010	-32.67	0.774	-168.32
3.0 GHz	0.969	-178.09	1.08	51.45	0.010	-33.60	0.779	-168.31
3.2 GHz	0.970	-178.26	0.99	49.32	0.010	-35.40	0.789	-168.33
3.4 GHz	0.971	-178.41	0.91	47.27	0.010	-37.11	0.800	-168.40
3.6 GHz	0.972	-178.56	0.84	45.30	0.009	-38.75	0.809	-168.50
3.8 GHz	0.973	-178.70	0.78	43.41	0.009	-40.31	0.818	-168.63
4.0 GHz	0.974	-178.84	0.73	41.59	0.009	-41.79	0.827	-168.79
4.2 GHz	0.975	-178.97	0.67	39.85	0.009	-43.21	0.835	-168.97
4.4 GHz	0.976	-179.09	0.63	38.16	0.009	-44.56	0.843	-169.16
4.6 GHz	0.976	-179.22	0.59	36.54	0.008	-45.85	0.851	-169.37
4.8 GHz	0.977	-179.34	0.55	34.98	0.008	-47.08	0.858	-169.59
5.0 GHz	0.978	-179.46	0.52	33.48	0.008	-48.25	0.864	-169.83
5.2 GHz	0.979	-179.58	0.49	32.03	0.008	-49.37	0.870	-170.06
5.4 GHz	0.979	-179.69	0.46	30.63	0.008	-50.43	0.876	-170.30
5.6 GHz	0.980	-179.80	0.43	29.28	0.007	-51.45	0.882	-170.55
5.8 GHz	0.980	-179.91	0.41	27.97	0.007	-52.42	0.887	-170.79
6.0 GHz	0.981	-179.98	0.39	26.71	0.007	-53.35	0.892	-171.04

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**Typical Die S-Parameters (Small Signal,  $V_{DS} = 28\text{ V}$ ,  $I_{DQ} = 800\text{ mA}$ , magnitude / angle)**

Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.966	-169.62	7.61	88.58	0.010	-0.60	0.693	-174.43
600 MHz	0.966	-171.35	6.34	86.43	0.010	-2.57	0.696	-174.53
700 MHz	0.966	-172.58	5.42	84.54	0.010	-4.29	0.698	-174.48
800 MHz	0.966	-173.51	4.73	82.80	0.010	-5.85	0.700	-174.35
900 MHz	0.967	-174.23	4.20	81.17	0.010	-7.31	0.703	-174.16
1.0 GHz	0.967	-174.81	3.76	79.62	0.010	-8.68	0.706	-173.95
1.1 GHz	0.967	-175.29	3.41	78.13	0.010	-10.00	0.709	-173.72
1.2 GHz	0.967	-175.69	3.11	76.69	0.010	-11.27	0.712	-173.47
1.3 GHz	0.967	-176.03	2.86	75.28	0.009	-12.51	0.715	-173.23
1.4 GHz	0.968	-176.32	2.64	73.91	0.009	-13.70	0.718	-172.99
1.5 GHz	0.968	-176.58	2.45	72.57	0.009	-14.87	0.722	-172.75
1.6 GHz	0.968	-176.80	2.29	71.26	0.009	-16.01	0.726	-172.52
1.7 GHz	0.969	-177.00	2.14	69.97	0.009	-17.13	0.729	-172.30
1.8 GHz	0.969	-177.18	2.01	68.71	0.009	-18.22	0.733	-172.09
1.9 GHz	0.969	-177.35	1.89	67.46	0.009	-19.30	0.737	-171.90
2.0 GHz	0.970	-177.49	1.78	66.24	0.009	-20.35	0.741	-171.72
2.1 GHz	0.970	-177.63	1.69	65.04	0.009	-21.38	0.746	-171.55
2.2 GHz	0.970	-177.76	1.60	63.85	0.009	-22.39	0.750	-171.39
2.3 GHz	0.971	-177.88	1.52	62.69	0.009	-23.38	0.754	-171.25
2.4 GHz	0.971	-177.99	1.44	61.55	0.009	-24.35	0.758	-171.12
2.5 GHz	0.971	-178.09	1.37	60.42	0.009	-25.31	0.763	-171.00
2.6 GHz	0.972	-178.19	1.31	59.31	0.009	-26.25	0.767	-170.90
2.7 GHz	0.972	-178.28	1.25	58.22	0.009	-27.16	0.771	-170.81
2.8 GHz	0.972	-178.37	1.20	57.15	0.008	-28.07	0.776	-170.73
2.9 GHz	0.973	-178.45	1.15	56.09	0.008	-28.95	0.780	-170.66
3.0 GHz	0.973	-178.54	1.10	55.05	0.008	-29.82	0.784	-170.60
3.2 GHz	0.974	-178.69	1.01	53.02	0.008	-31.50	0.793	-170.52
3.4 GHz	0.974	-178.83	0.93	51.06	0.008	-33.12	0.801	-170.48
3.6 GHz	0.975	-178.97	0.87	49.17	0.008	-34.67	0.809	-170.48
3.8 GHz	0.976	-179.10	0.80	47.33	0.008	-36.16	0.817	-170.51
4.0 GHz	0.977	-179.22	0.75	45.56	0.007	-37.59	0.824	-170.56
4.2 GHz	0.977	-179.35	0.70	43.84	0.007	-38.96	0.831	-170.64
4.4 GHz	0.978	-179.46	0.66	42.18	0.007	-40.27	0.838	-170.74
4.6 GHz	0.978	-179.58	0.61	40.57	0.007	-41.53	0.845	-170.86
4.8 GHz	0.979	-179.69	0.58	39.02	0.007	-42.74	0.852	-170.99
5.0 GHz	0.980	-179.80	0.54	37.51	0.007	-43.90	0.858	-171.13
5.2 GHz	0.980	-179.90	0.51	36.06	0.007	-45.01	0.863	-171.29
5.4 GHz	0.981	179.99	0.48	34.65	0.006	-46.07	0.869	-171.46
5.6 GHz	0.981	179.89	0.46	33.28	0.006	-47.09	0.874	-171.63
5.8 GHz	0.982	179.79	0.43	31.96	0.006	-48.06	0.879	-171.81
6.0 GHz	0.982	179.69	0.41	30.67	0.006	-49.00	0.884	-171.99

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- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
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- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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